



KBP2005 THRU KBP210

Reverse Voltage - 50 to 1000 Volts Forward Current - 2.0 Amperes

SINGLE BRIDGE RECTIFIERS

Features

- ◆ Glass passivated die construction
- ◆ Low forward voltage drop
- ◆ High current capability
- ◆ High surge current capability
- ◆ Plastic material-UL flammability 94V-0

Mechanical Data

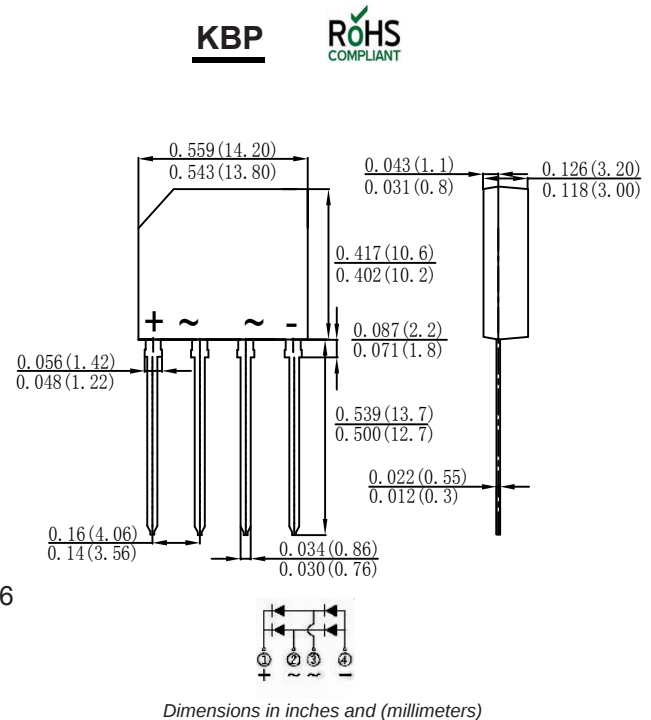
Case : JEDEC KBP Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0693 ounce, 1.35 grams



Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	HY KBP2005	HY KBP201	HY KBP202	HY KBP204	HY KBP206	HY KBP208	HY KBP210	UNITS
Marking Code									
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward output rectified current at $T_c=50^\circ\text{C}$ (Note 1)	$I_{(AV)}$	2.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	35							A
Maximum instantaneous forward voltage drop per bridge element at 2.0A	V_F	1.1							V
Maximum DC reverse current at rated DC blocking voltage $T_A=25^\circ\text{C}$ $T_A=125^\circ\text{C}$	I_R	10							μA
		1							mA
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	25							$^\circ\text{C/W}$
Operating junction temperature range	T_J	-55 to +150							$^\circ\text{C}$
storage temperature range	T_{STG}	-55 to +150							$^\circ\text{C}$

Note:1. Mounted on glass epoxy PC board with 1.3mm² solder pad.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C..



Ratings And Characteristic Curves

Fig. 1 Derating Curve for Output Rectified Current

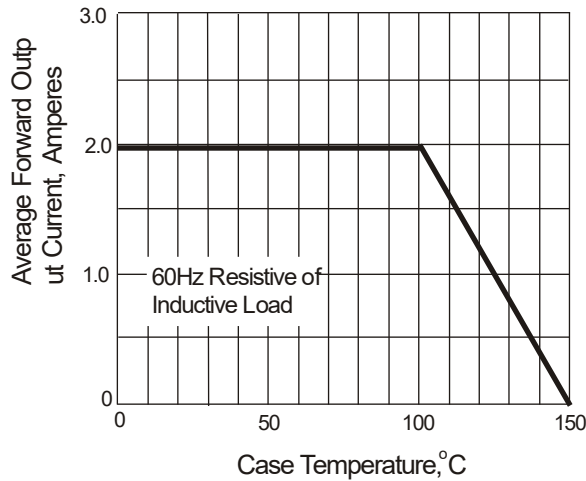


Fig. 2 Maximum Non-repetitive Peak Forward Surge Current

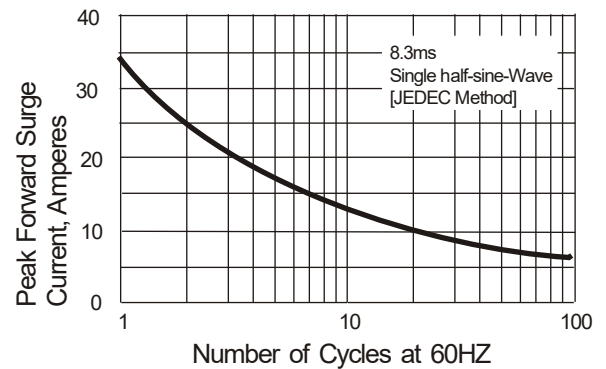


Fig. 3 Typical Instantaneous Forward Characteristics

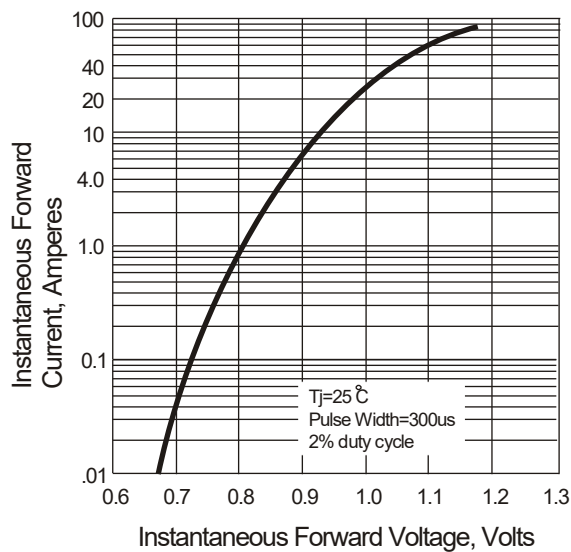


Fig. 4 Typical Reverse Characteristics

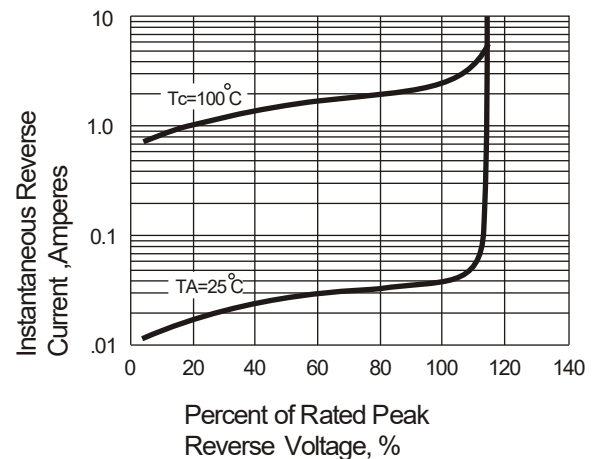


Fig. 5 Typical Junction Capacitance

